

Docket No.: 060891-0124



PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 31824
David E. Ludwig, et al. : Confirmation Number: 1014
Application No.: 10/806,037 : Group Art Unit: 3662
Filed: March 22, 2004 : Examiner: Luke D. Ratcliffe

For: **THREE-DIMENSIONAL IMAGING PROCESSING MODULE INCORPORATING STACKED LAYERS
CONTAINING MICROELECTRONIC CIRCUITS**

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

Transmitted herewith is an Amendment in the above-identified application.

- ☒ No additional fee is required.
☐ Applicant is entitled to small entity status under 37 CFR 1.27
☐ Also attached:


The fee has been calculated as shown below:

	NO. OF CLAIMS	HIGHEST PREVIOUSLY PAID FOR	EXTRA CLAIMS	RATE	FEE
Total Claims	12	20	0	\$50.00 =	\$0.00
Independent Claims	1	3	0	\$200.00 =	\$0.00
Multiple dependent claims newly presented					\$0.00
Fee for extension of time					\$0.00
					\$0.00
Total of Above Calculations					\$0.00

- ☐ Please charge my Deposit Account No. 502203 in the amount of \$0.00. An additional copy of this transmittal sheet is submitted herewith.
- ☒ The Commissioner is hereby authorized to charge payment of any fees associated with this communication or credit any overpayment, to Deposit Account No. 502203, including any filing fees under 37 CFR 1.16 for presentation of extra claims and any patent application processing fees under 37 CFR 1.17.

Respectfully submitted,

McDERMOTT WILL & EMERY LLP


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Date: February 28, 2006

**Please recognize our Customer No. 31824 as our
correspondence address.**



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Filed: March 22, 2004	:	Examiner: Luke D. Ratcliffe
	:	
For: THREE-DIMENSIONAL IMAGING:	:	
PROCESSING MODULE	:	
INCORPORATING STACKED	:	
LAYERS CONTAINING	:	
MICROELECTRONIC CIRCUITS	:	

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT

Sir:

In response to the Office Action dated December 2, 2005, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.